

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Douglas M. Albert et al.

Serial No.: Unknown

Filed: Herewith

Titled: METHOD FOR THINNING
SEMICONDUCTOR WAFERS
WITH CIRCUITS AND
WAFERS MADE BY THE SAME

DECLARATION OF ASSIGNEE CLAIMING SMALL ENTITY STATUS

As an assignee in and to the above identified invention and application, I hereby declare that I qualify as an assignee as defined in 37 CFR 1.9 (c) and (d), for purposes of paying reduced fees under Sections 41(a) and (b) of Title 35, United States Code, to the Patent and Trademark Office with regard to the invention set forth in the application identified above.

I have not assigned, granted, conveyed or licensed, and am under no obligation under contract or law to assign, grant, convey or license, any rights in the invention to any person who could not be classified as an independent inventor under 37 CFR 1.9(c) if that person had made the invention, or to any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e).

Each person, concern or organization to which I have assigned, granted conveyed or licensed, or am under an obligation under contract or law to assign, grant , convey, or license, any rights in the invention are identified as follows:

NONE

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or

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[illegible]

As a below named inventor of the invention claimed in the below application for United States Letters Patent, I hereby declare that:

INVENTORSHIP IDENTIFICATION

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the invention which is claimed and for which a patent is sought on the invention entitled:

METHOD FOR THINNING SEMICONDUCTOR WAFERS WITH CIRCUITS AND WAFERS MADE BY THE SAME

the specification of which was filed of even date herewith.

ACKNOWLEDGMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR

I hereby state that I have reviewed and understand the contents of the above application, including the specification and claims thereof, and acknowledge my duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

PRIORITY CLAIMS

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate, or of any PCT international application(s) designating at least one country other than the United States of America, filed by me on the same subject matter as set forth in the attached application, namely:

- NONE

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

- U.S. Provisional Application Serial No. 60/065,088, filed November 11, 1997.

I hereby claim the benefits under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

- NONE

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorney(s) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

Joseph C. Andras

Registration No. 33,469

Please send correspondence and direct telephone calls to:

Joseph C. Andras
LAW OFFICES OF JOSEPH C. ANDRAS
650 Town Center Drive, Suite 650
Costa Mesa, California 92626
(714) 759-4760

DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under § 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF FIRST OR SOLE INVENTOR:

Full Name:	Douglas M. Albert
Citizenship:	United States of America
Post Office Address:	17743 Plum Tree Lane Yorba Linda, California 92886
Residence:	Same as PO Address

Date:

11/10/98

Inventor's Signature:

Douglas M. Albert

SIGNATURE OF SECOND JOINT INVENTOR:

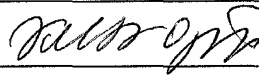
Full Name: Volkan H. Ozguz
Citizenship: Turkey

Post Office Address: 8 Palatine
Aliso Viejo, California 92656

Residence: Same as PO Address

Date: 11/10/98

Inventor's Signature:



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I have not assigned, granted, conveyed or licensed, and am under no obligation under contract or law to assign, grant, convey or license, any rights in the invention to any person who could not be classified as an independent inventor under 37 CFR 1.9(c) if that person had made the invention, or to any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e).

Each person, concern or organization to which I have assigned, granted conveyed or licensed, or am under an obligation under contract or law to assign, grant , convey, or license, any rights in the invention are identified as follows:

IRVINE SENSORS CORPORATION

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate.

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Signature of Second Joint Inventor